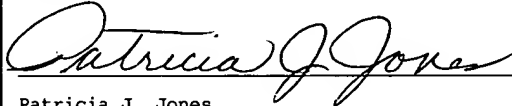


Attorney Docket No. TI-19646**"EXPRESS MAIL"** mailing label number **TB309674057**,Date of Deposit: 3-17-95. I hereby certify that the accompanying Application is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to the Commissioner of Patents and Trademarks, Washington, D.C. 20231.

Patricia J. Jones

DEPARTMENT OF COMMERCE
HONORABLE COMMISSIONER OF
PATENTS AND TRADEMARKS
Washington, DC 20231

Sir:

Transmitted herewith for filing is the patent application of:

Inventor(s): **Richard M. Weber and Kerrin A. Rummel**For: **"Construction of Phase Change Material Embedded Electronic Circuit Boards and Electronic Circuit Board Assemblies using Porous and Fibrous Media"**

Enclosed is (are):

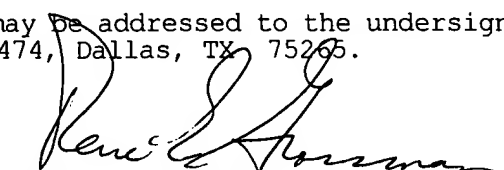
1 sheet(s) of formal drawings.

FEE CALCULATION					FEE
	ACTUAL	ALLOWED	NUMBER EXTRA	RATE	BASIC FEE \$730.00
Total Claims	20	- 20 =	0	x \$22 =	\$ 00.00
Independent Claims	01	- 03 =	0	x \$76 =	\$ 00.00
Total Filing Fee					\$ 730.00

Please charge Deposit Account No. 20-0668 in the amount of the Total Fees set forth. The commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Account No. 20-0668. This form is submitted in triplicate.

All correspondence related to this application may be addressed to the undersigned at Texas Instruments Incorporated, M/S 219, P.O. Box 655474, Dallas, TX 75265.

Date

3/17/95
Rene E. Grossman
Registration No. 22,656